

# EMC '09/Kyoto

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## 2009 International Symposium on Electromagnetic Compatibility, Kyoto

July 20-24, 2009

Kyoto International Conference Center, Kyoto, JAPAN



### Session Topics

- 1) Measurement Techniques
- 2) EMC Test Facilities
- 3) Standards and Regulations
- 4) System-Level EMC
- 5) Chip and Package Level EMC
- 6) PCB and Circuit Design for EMI Control
- 7) Transmission Lines and Cables
- 8) Signal and Power Integrity
- 9) Immunity / Susceptibility
- 10) ESD and Transients
- 11) Shielding and Grounding
- 12) EM Absorber
- 13) Numerical Modeling
- 14) Biological Effects and Safety
- 15) EM Environment Measurement
- 16) Power System EMC
- 17) Automotive EMC
- 18) Communication System EMC
- 19) EM Wave Propagation and Scattering
- 20) Lightning and Overvoltages Protection
- 21) Electromagnetic Product Safety
- 22) EMC Management

### Important Dates

September 1, 2008 (Mon.) : Paper Submission System Open

December 1, 2008 (Mon.) : Deadline for Full-length Paper Submission

March 1, 2009 (Sun.) : Notification of Paper Acceptance

May 1, 2009 (Fri.) : Deadline for Speaker's Registration

### Information and Contact

Web-site: <http://www.ieice.org/emc09/>

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IEEE EMC Society (IEEE EMC-S)

IEEE Kansai Section

IEEE EMC-S Japan and Sendai Chapters

#### TECHNICAL COOPERATION

CISPR, IEC/TC77, URSI, VCCI, JIEP



# Call for Papers

